

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.	:	10/595809	Confirmation No.	7041
Applicant	:	Shinji Okamoto et al.		
Filed	:	July 14, 2006		
TC/A.U.	:	1755		
Examiner	:	N/A		
Title	:	CONNECTOR CHIP AND MANUFACTURING METHOD THEREOF		
Docket No.	:	NIS-16657		
Customer No.	:	040854		

LETTER

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir/Madam:

Applicant encloses herewith the required Declaration for the above-identified application. The \$130.00 fee to cover the late filing fee surcharge for the enclosed declaration was included in the filing fee paid on July 14, 2006.

If there are any further fees resulting from this communication, please charge the same to Deposit Account No. 18-0160, Order No. NIS-16657.

Respectfully submitted,

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